**New Product** 

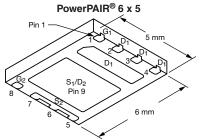


## SiZ918DT

Vishay Siliconix

## Dual N-Channel 30 V (D-S) MOSFETs

PRODUCT SUMMARY						
	V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) (Max.)	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)		
Channel-1	30	0.0120 at V <sub>GS</sub> = 10 V	16 <sup>a</sup>	6.8 nC		
Channel-1	30	0.0145 at V <sub>GS</sub> = 4.5 V	16 <sup>a</sup>	0.0 110		
Channel-2	30	0.0037 at V <sub>GS</sub> = 10 V	28 <sup>a</sup>	32 nC		
Channel-2	- 30	0.0045 at V <sub>GS</sub> = 4.5 V	28 <sup>a</sup>	32 110		

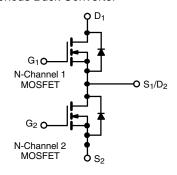


#### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFETs
- 100  $\%~\text{R}_{\rm g}$  and UIS Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

#### APPLICATIONS

- Notebook System Power
- POL Synchronous Buck Converter



Ordering Information: SiZ918DT-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter		Symbol	Channel-1	Channel-2	Unit	
Drain-Source Voltage		V <sub>DS</sub>	30		V	
Gate-Source Voltage		V <sub>GS</sub>	± 20		V	
	T <sub>C</sub> = 25 °C		16 <sup>a</sup>	28 <sup>a</sup>		
Continuous Drain Current (T 150 °C)	T <sub>C</sub> = 70 °C		16 <sup>a</sup>	28 <sup>a</sup>	•	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	Ι <sub>D</sub>	14.3 <sup>b, c</sup>	26 <sup>a, b, c</sup>		
	T <sub>A</sub> = 70 °C		11.4 <sup>b, c</sup>	21 <sup>a, b, c</sup>		
Pulsed Drain Current (t = 300 μs)		I <sub>DM</sub>	50	110	A	
Continuous Source Drain Diode Current	T <sub>C</sub> = 25 °C	- I <sub>S</sub>	16 <sup>a</sup>	28 <sup>a</sup>		
Continuous Source Drain Diode Current	T <sub>A</sub> = 25 °C		3.4 <sup>b, c</sup>	4.3 <sup>b, c</sup>		
Single Pulse Avalanche Current		I <sub>AS</sub>	18	35		
Single Pulse Avalanche Energy L = 0.1 mH		E <sub>AS</sub>	16	61	mJ	
	T <sub>C</sub> = 25 °C		29	100	W	
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	18	64		
	T <sub>A</sub> = 25 °C		4.2 <sup>b, c</sup>	5.2 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		2.7 <sup>b, c</sup>	3.3 <sup>b, c</sup>		
Operating Junction and Storage Temperature Ra	ange	T <sub>J</sub> , T <sub>stg</sub>	- 55 t	o 150	•••	
Soldering Recommendations (Peak Temperature) <sup>d, e</sup>			20	60	°C	

#### THERMAL RESISTANCE RATINGS

Parameter			Char	nel-1	Char	inel-2	
		Symbol	Тур.	Max.	Тур.	Max.	Unit
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 10 s	R <sub>thJA</sub>	24	30	19	24	°C/W
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	3.4	4.3	1	1.25	0/11

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. See solder profile (www.vishay.com/doc?73257). The PowerPAIR is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components. f.

Maximum under steady state conditions is 65 °C/W for channel-1 and 55 °C/W for channel-2.

Document Number: 63783 S12-0543 Rev. A, 12-Mar-12 For more information please contact: pmostechsupport@vishav.com

www.vishay.com



RoHS COMPLIANT HALOGEN FREE

## Vishay Siliconix



<b>SPECIFICATIONS</b> ( $T_J = 25^{\circ}$				NA!	<b>T</b>	N	11-11	
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static					1	r		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$ $V_{GS} = 0 V, I_D = 250 \mu A$	Ch-1	30			v	
			Ch-2	30				
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA	Ch-1		33		-	
		I <sub>D</sub> = 250 μA	Ch-2		37		mV/°	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	Ch-1		- 5			
	0.0() 0	2	I <sub>D</sub> = 250 μA Ch-2 - 7.5					
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	Ch-1	1		2.2	v	
	- G3(iii)	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	Ch-2	1.2		2.2		
Gate Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	Ch-1			± 100	nA	
g-	000		Ch-2			± 100		
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	Ch-1			1	-	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		Ch-2			1	μA	
Zoro dato Voltago Drain Carroni	-055	$\begin{array}{c c} & U_{DS} = 30 \text{ V},  \text{V}_{GS} = 0  \text{V},  \text{T}_{\text{J}} = 55 ^{\circ}\text{C} & \text{Ch-1} \\ \hline & \text{V}_{DS} = 30  \text{V},  \text{V}_{GS} = 0  \text{V},  \text{T}_{\text{J}} = 55 ^{\circ}\text{C} & \text{Ch-2} \\ \hline & \text{V}_{DS} \ge 5  \text{V},  \text{V}_{GS} = 10  \text{V} & \text{Ch-1} & \text{2} \\ \hline & \text{V}_{DS} \ge 5  \text{V},  \text{V}_{GS} = 10  \text{V} & \text{Ch-2} & \text{2} \\ \hline & \text{V}_{GS} = 10  \text{V},  \text{I}_{D} = 13.8  \text{A} & \text{Ch-1} \\ \hline & \text{V}_{GS} = 10  \text{V},  \text{I}_{D} = 20  \text{A} & \text{Ch-2} \end{array}$				5	μΛ	
						5		
On Olate Davis One alb		$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	Ch-1	20			~	
On-State Drain Current <sup>D</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	Ch-2	20			A	
	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 13.8 A	Ch-1		0.0100	0.0120		
h		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A	Ch-2		0.0030	0.0037		
Drain-Source On-State Resistance <sup>b</sup>		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 12.6 \text{ A}$	Ch-1		0.0120	0.0145	5 Ω	
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 20 A	Ch-2		0.0035	0.0045		
		V <sub>DS</sub> = 10 V, I <sub>D</sub> = 13.8 A C			47		1	
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	$V_{\rm DS} = 10 \text{ V}, \text{ I}_{\rm D} = 20 \text{ A}$	Ch-2		116		S	
Dynamic <sup>a</sup>					1	1	1	
			Ch-1		790			
Input Capacitance	C <sub>iss</sub>	Channel-1	Ch-2		3830			
	6	$V_{DS}$ = 15 V, $V_{GS}$ = 0 V, f = 1 MHz	Ch-1		190			
Output Capacitance	C <sub>oss</sub>	Channel-2	Ch-2		670		- pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	Ch-1		76			
neverse transier Capacitance	Orss		Ch-2		315			
		$V_{DS}$ = 15 V, $V_{GS}$ = 10 V, $I_{D}$ = 13.8 A	Ch-1		14	21	nC	
Total Gate Charge	Qg	$V_{DS}$ = 15 V, $V_{GS}$ = 10 V, $I_{D}$ = 20 A	Ch-2		67.3	105		
Total Gate Onlarge	αg		Ch-1		6.8	11		
		Channel-1	Ch-2		32	48		
Gate-Source Charge	0	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 13.8 \text{ A}$	Ch-1		2.6			
Gate Source Charge	Q <sub>gs</sub>	Channel-2	Ch-2		10.8			
Gate-Drain Charge	Q <sub>gd</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$	Ch-1		1.9			
	∽yu		Ch-2		9.3			
Gate Resistance	R <sub>g</sub>	f = 1 MHz		0.4	2	4	Ω	
	У	· · · · · · · · · · · · · · · · · · ·	Ch-2	0.2	1.1	2.2		

Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

Document Number: 63783 S12-0543 Rev. A, 12-Mar-12



Vishay Siliconix

SPECIFICATIONS (T <sub>J</sub> = 25 °C) Parameter	Symbol	Test Conditions		Min.	Тур.	Max.	Unit
Dynamic <sup>a</sup>	Cymbol				199.	max.	Onic
•			Ch-1		15	30	
Turn-On Delay Time	t <sub>d(on)</sub>	Channel-1	Ch-2		30	60	
Rise Time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, \text{ R}_{L} = 1.5 \Omega$	Ch-1		12	20	
nise fillie		$\text{I}_\text{D} \cong$ 10 A, $\text{V}_\text{GEN}$ = 4.5 V, $\text{R}_\text{g}$ = 1 $\Omega$	Ch-2		33	65	
Turn-Off Delay Time	t <sub>d(off)</sub>	Channel-2	Ch-1		20	40	
	•u(011)	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$	Ch-2		40	80	
Fall Time	t <sub>f</sub>	$I_D \cong$ 10 A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$	Ch-1		10	20	
			Ch-2		12	25	ns
Turn-On Delay Time	t <sub>d(on)</sub>	Channel-1	Ch-1		10	-	
	- ( - )	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{L}} = 1.5 \Omega$	Ch-2		15		
Rise Time	t <sub>r</sub>		Ch-1		12	-	
	$t_r$ $I_D \cong 10 \text{ A}, V_{\text{GEN}} = 10 \text{ V}, R_g = 1 \Omega$ Ch-2				22 20	-	
Turn-Off Delay Time	t <sub>d(off)</sub>		Ch-2		40		
		$V_{DD} = 15 \text{ V}, \text{ R}_{\text{L}} = 1.5 \Omega$	Ch-1		10	20	ns 20 30 20 25 40 80 20 20 20 16 28 A
Fall Time	t <sub>f</sub>	${\rm I_D}\cong {\rm 10~A},{\rm V_{GEN}}={\rm 10~V},{\rm R_g}={\rm 1~\Omega}$	Ch-2		10	20	
Drain-Source Body Diode Characteristic	cs	1	0.12				I
Continuous Source-Drain Diode Current	ا <sub>S</sub>	T <sub>C</sub> = 25 °C	Ch-1			16	
Continuous Source-Drain Diode Current	IS	10-23 0	Ch-2			28	Δ
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>		Ch-1			50	
Fuise Diode Forward Current	.21/1		Ch-2			110	
Body Diode Voltage	V <sub>SD</sub>	$I_{\rm S} = 10 \text{ A}, V_{\rm GS} = 0 \text{ V}$	Ch-1		0.85	1.2	v
Body Blode Vollage	- 3D	$I_{S} = 10 \text{ A}, V_{GS} = 0 \text{ V}$	Ch-2		0.8	1.2	v
Body Diode Reverse Recovery Time	t <sub>rr</sub>		Ch-1		20	40	ns
Body Blode Heverse Hecovery Hille	٩r	Observal 1	Ch-2		30	60	113
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	Channel-1 I <sub>F</sub> = 10 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C	Ch-1		10	20	nC
		1 - 100, 0, 0, 0, 0 = 100, 0, 0, 0, 0 = 20, 0	Ch-2		21	40	
Reverse Recovery Fall Time	t <sub>a</sub>	Channel-2	Ch-1		11		
	-a	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$	Ch-2		17		ns
Reverse Recovery Rise Time	very Rise Time t <sub>b</sub>		Ch-1		9		
-	_		Ch-2		13		

Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### Vishay Siliconix



55 °C

3.0

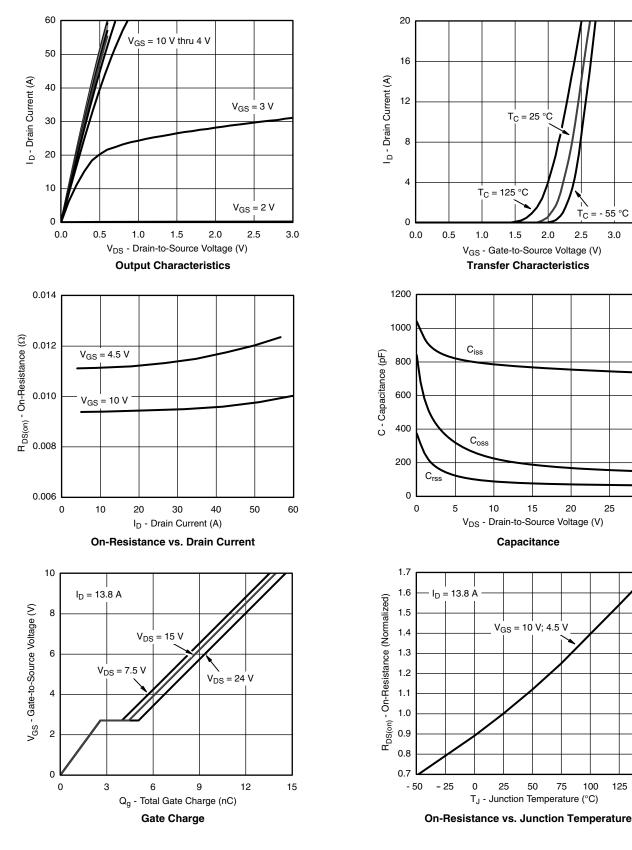
25

30

3.5

T<sub>C</sub>

#### CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



For more information please contact: pmostechsupport@vishay.com

Document Number: 63783 S12-0543 Rev. A, 12-Mar-12

125

150

100



Document Number: 63783

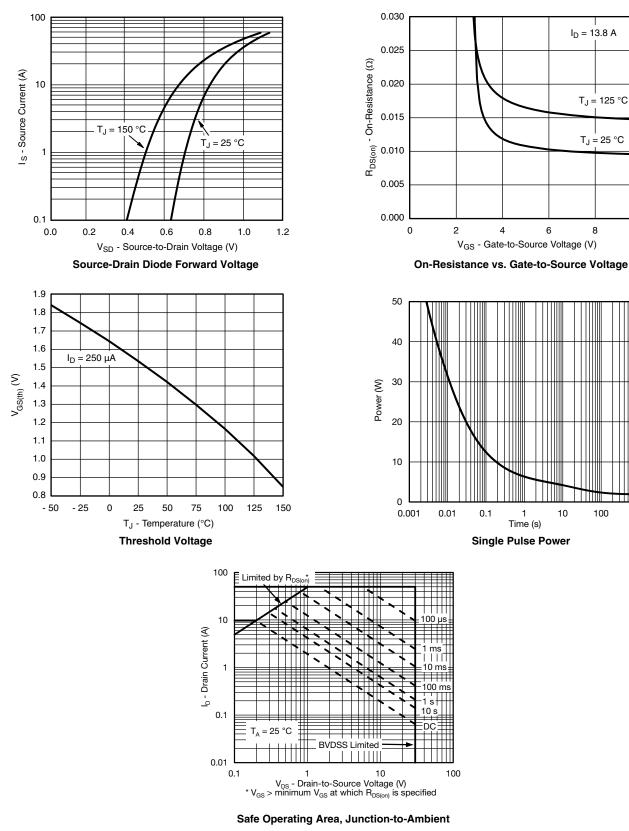
S12-0543 Rev. A, 12-Mar-12

## SiZ918DT Vishay Siliconix

10

1000

#### CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

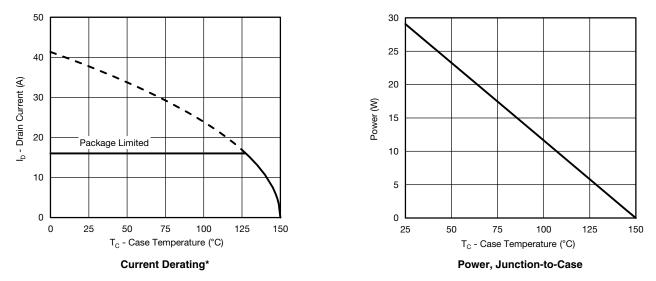


For more information please contact: pmostechsupport@vishay.com

Vishay Siliconix



#### CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

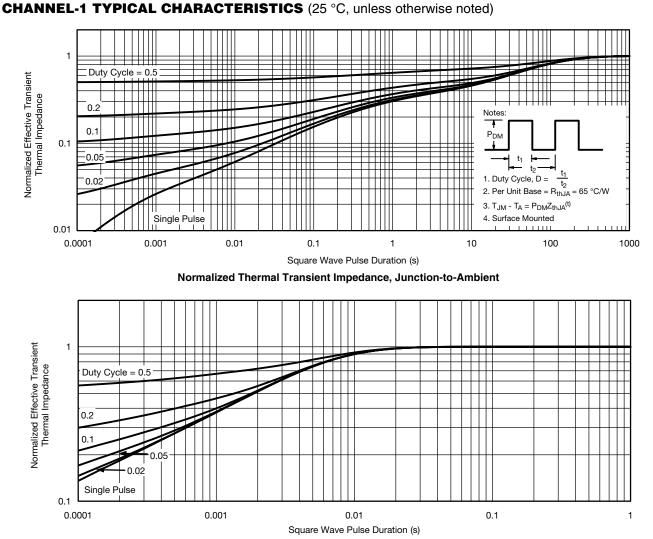
Document Number: 63783 S12-0543 Rev. A, 12-Mar-12

**New Product** 



## SiZ918DT Vishay Siliconix

7

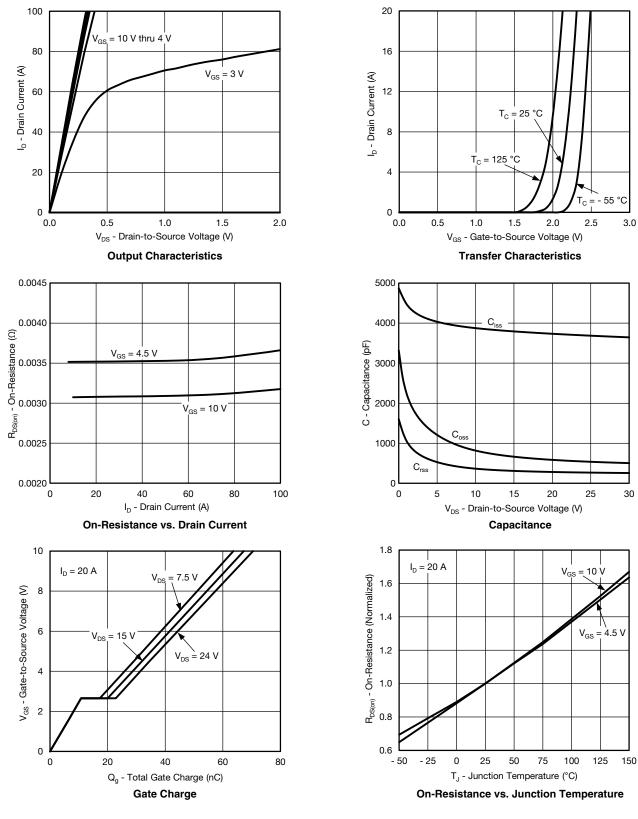


Normalized Thermal Transient Impedance, Junction-to-Case

Document Number: 63783 For more information please contact: pmostechsupport@vishay.com www.vishay.com S12-0543 Rev. A, 12-Mar-12

Vishay Siliconix





For more information please contact: pmostechsupport@vishay.com

Document Number: 63783 S12-0543 Rev. A, 12-Mar-12

VISHAY

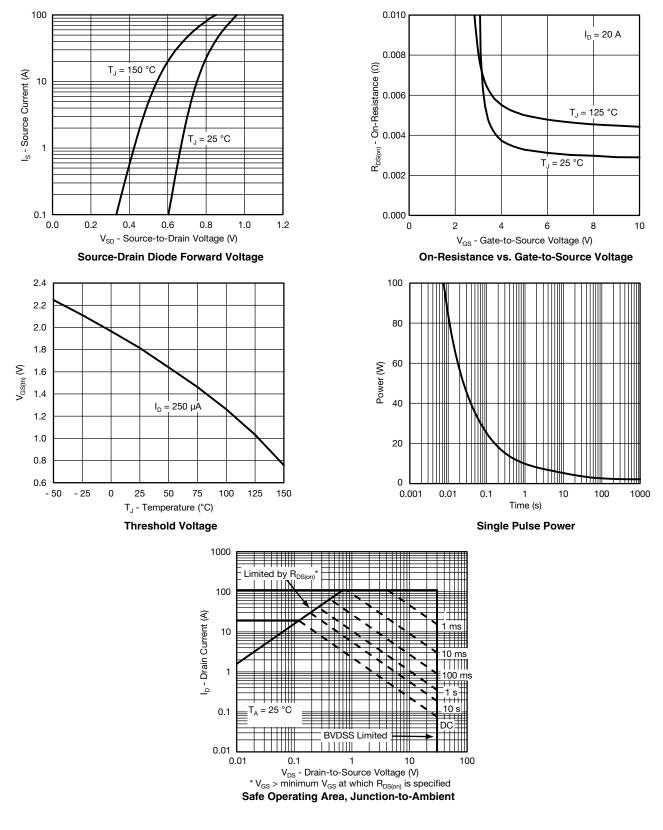
3.0

30



## SiZ918DT Vishay Siliconix





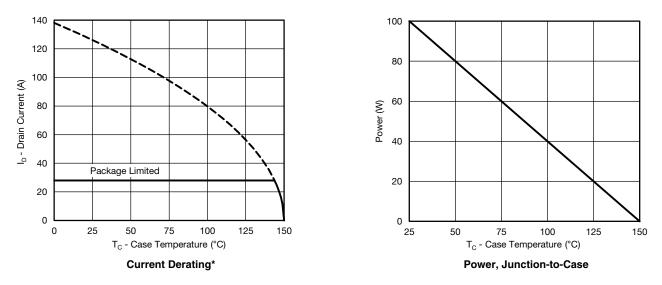
Document Number: 63783 S12-0543 Rev. A, 12-Mar-12 For more information please contact: pmostechsupport@vishay.com

This document is subject to change without notice. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000 Downloaded from Elcodis.com electronic components distributor

Vishay Siliconix



### CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



\* The power dissipation  $P_D$  is based on  $T_{J(max.)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

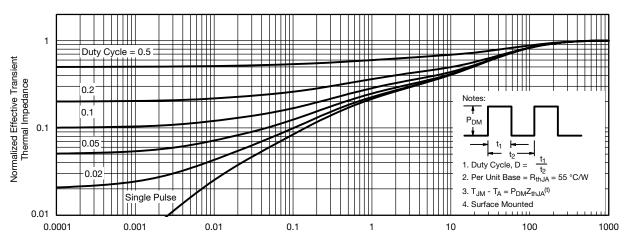
**New Product** 



### SiZ918DT Vishay Siliconix

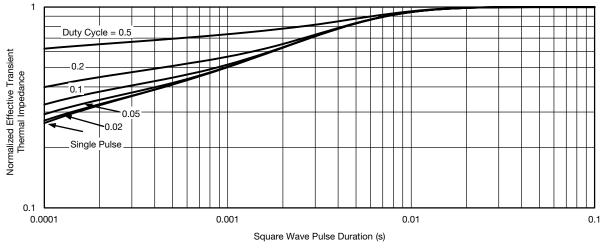
11





Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

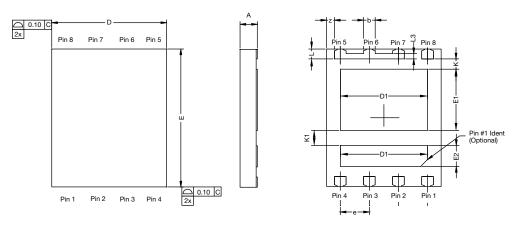
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63783.

Document Number: 63783 For more information please contact: pmostechsupport@vishav.com www.vishay.com S12-0543 Rev. A, 12-Mar-12



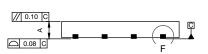
Vishay Siliconix

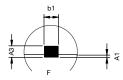
PowerPAIR<sup>®</sup> 6 x 5 Case Outline



TOP SIDE VIEW

BACK SIDE VIEW





		MILLIMETERS		INCHES				
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
А	0.70	0.75	0.80	0.028	0.030	0.032		
A1	0.00	-	0.10	0.000	-	0.004		
A3		0.20 REF			0.008 REF			
b		0.51 BSC			0.020 BSC			
b1		0.25 BSC	0.010 BSC					
D	5.00 BSC				0.197 BSC			
D1	3.75	3.80	3.85	0.148	0.150	0.152		
E	6.00 BSC			0.236 BSC				
E1	2.62	2.67	2.72	0.103 0.105		0.107		
E2	0.87	0.92	0.97	0.034	0.036	0.038		
е		1.27 BSC			0.005 BSC			
К		0.45 TYP.			0.018 TYP.			
K1		0.66 TYP.			0.026 TYP.			
L		0.43 BSC			0.017 BSC			
L3		0.23 BSC		0.009 BSC				
z	0.34 BSC			0.013 BSC				

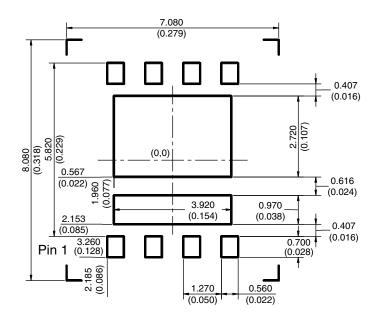
Revision: 07-Nov-11

1



Vishay Siliconix

#### **RECOMMENDED MINIMUM PAD FOR PowerPAIR® 6 x 5**



Recommended Minimum Pad Dimensions in mm (inches)

Document Number: 67480 Revision: 13-Jan-11



Vishay

## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

## **Material Category Policy**

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.